



DRAM Market Update – 2012 & Beyond

- The End of the Perfect Competitive Market-

完全競爭市場的終結

DRAM Team

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Agenda



Demand

- Marco Economy
- 2012 DRAM Industry Outlook
- Demand PC (NB, Ultrabook, DT) & Mobile (Tablet and Smartphone)
- 5 Years Demand Landscape

Supply

- Changing Mix of Supply
- Supply by Application
- Companies' Profitability and Market Share
- New Market Cycle

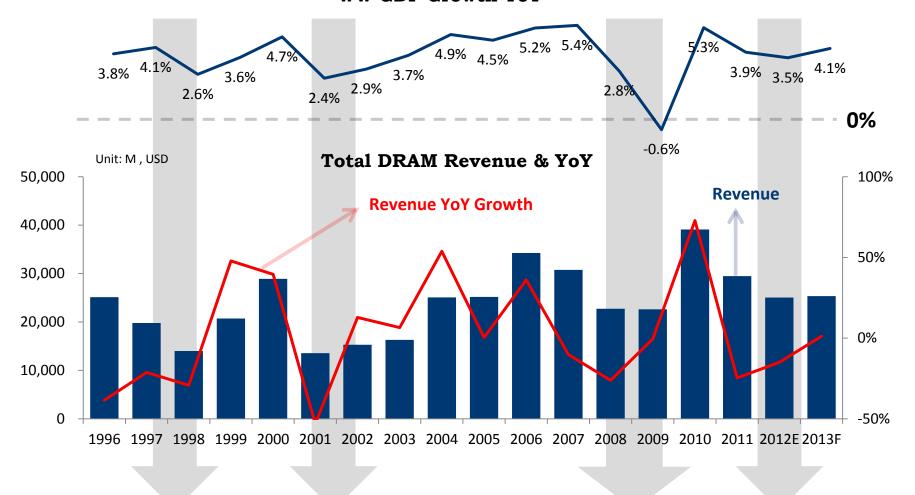
Conclusion



2012: 2nd Dip Unlikely but Slow Recovery TRENDFORCE

WW GDP Shows High Correlation with DRAM Industry





Asia Financial Crisis

Dot Com Bubble **Financial Crisis**

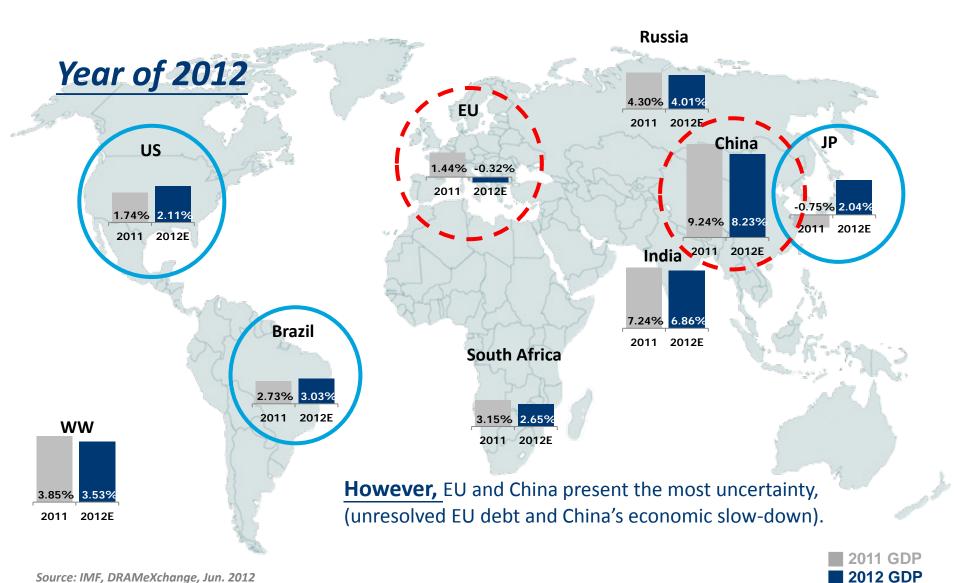
Minor Recession??



2012 - Market Gradually Improves in 2H

TRENDFORCE

Solid GDP Growth in US, JP and Other Emerging Countries

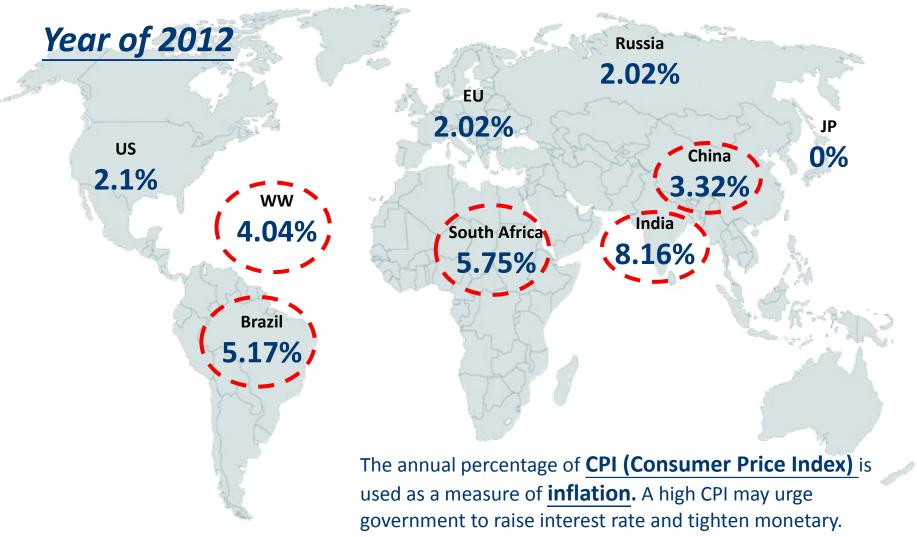




However, Uncertainty Remains...



CPI Represents Potential Risk of Inflation among Regions





2012 DRAM Industry Outlook

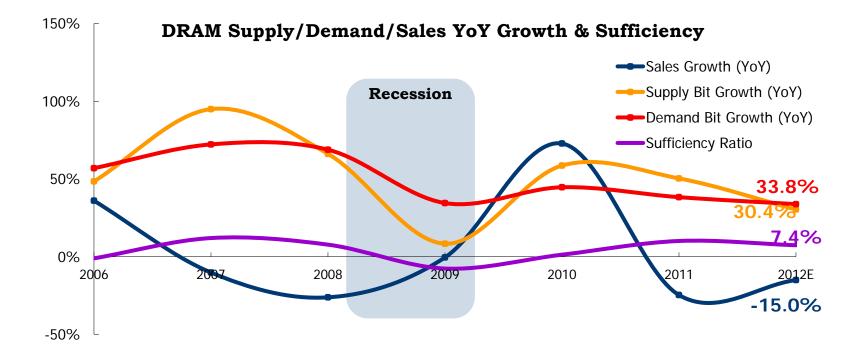




2012: Healthier sufficiency (yet still oversupply), ASP (PC+non PC DRAM) drop slows (YoY ~35%)

Future key watch points:

- (1) Supply: Status of DRAM capacity withdrawal; Elpida's resolution of financial restructure
- (2) Demand: Stimulations in 2H'12 (Win8, Ultrabook, Intel's Ivy Bridge & Romley)







Ultrabook Memory Solution Unsettled

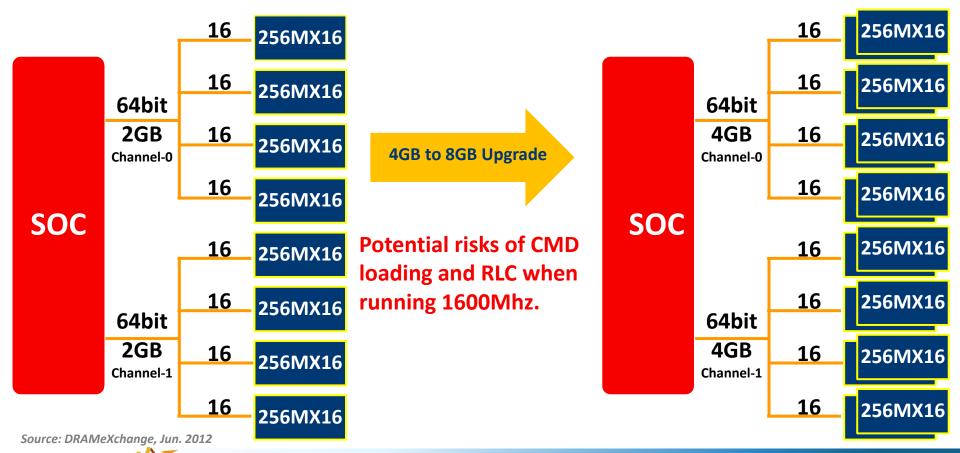


DDR3L, DDR3M and LPDDR3 x16/x32 Are the Options

Segmentation is the Key for Memory Solutions

- ☐ Always Connected: LPDDR3x16/x32; however, x32 product is the only solution that Intel Haswell supports.
- Not Always Connected: DDR3LMx16 or DDR3Lx16

LPDDR3 x16 Simulation when Ultrabook Density Increases to 8GB



2012 Demand Outlook – Mobile DRAM





	Tablet PC	Smartphone	Featurephone Image: Control of the control of th
High-end, Mainstream Segment	2012 Shipment (E) 76.2M (83.7%)	2012 Shipment (E) 467.5M (77.2%)	2012 Shipment (E) 529M (55%)
	Non-iPad: 8Gb → 16Gb LPDDR2 iPad: 4Gb → 8Gb LPDDR2	H: 8Gb LPDDR2, eMCP and discrete solution	NAND-based MCP 1+512
		M: Various Offering, 4Gb LPDR1/8Gb LPDR2	
Low-end Segment	2012 Shipment (E) 15M (16.3%)	2012 Shipment (E) 172.8M (22.8%)	2012 Shipment (E) 428M (45%)
	4Gb → 6Gb LPDDR2	MCP 4+4 or 4+2 LPDDR1→LPDDR2 (2Q)	NOR-based MCP 32Mb



2013: Fast Transition in Mobile Market



LPDDR2 & Dual-core Chips Dominate Market

Note 1 : □Quad □Dual □Single

Note 2 : ■LPDDR3 ■LPDDR2 ■LPDDR1

AP33 SP30 AP40 OLIALCOMM[®] **MSM8X60 MSM7227A MSM8X74 MSM8X28 MSM8X26 TEXAS** OMAP64X0 OMAP44X0 OMAP54X0 OMAP4XX0 MT6575 MEDIATEK MT6577 MT658X ST ERICSSON U8500 U9500 **APQ8055** 2013 2012

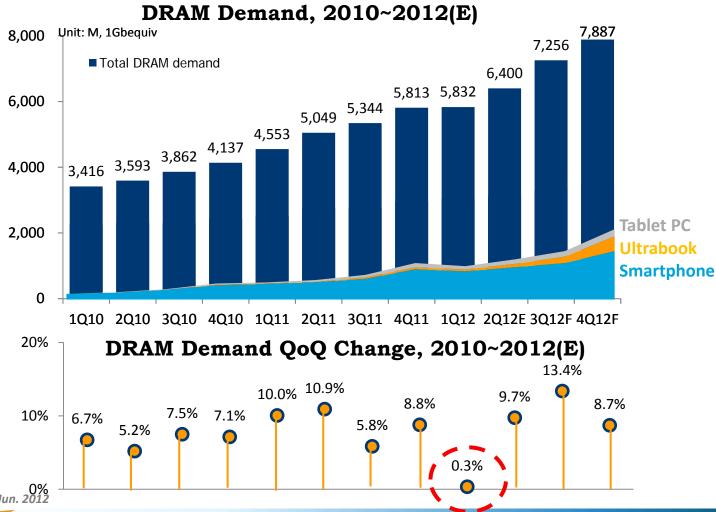


2012 DRAM Demand Status



1Q12 Below Seasonal, Demand Gradually Improves from 3Q

- 1Q12 demand below expectation(weak PC build), oversupply continued.
- Market estimates demand will improve in 2H, representing stronger seasonality.

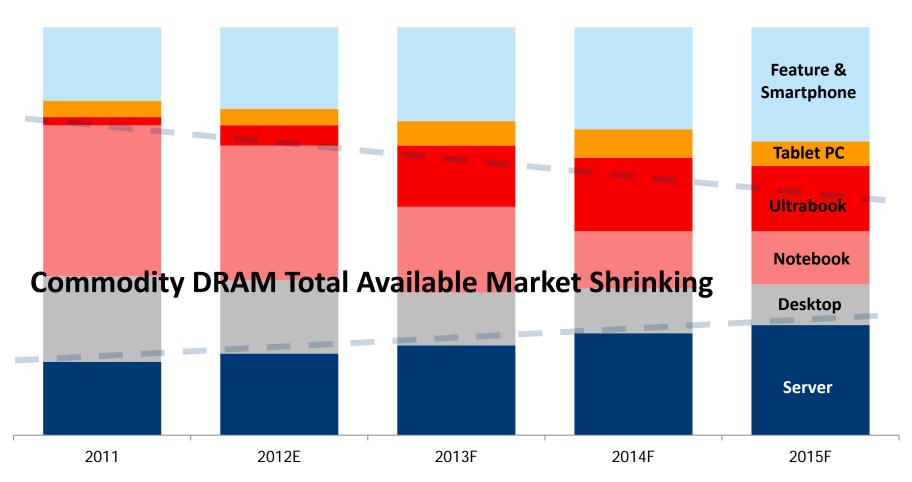


5 Years DRAM Demand Landscape



Everything is about Cloud Computing Trend

- Thin and light guarantees the popularity of adoption. Market will be driven by Mobile DRAM and low-power consumption DRAM.
- In 2015, Ultrabook + Cellphone + Server will take majority of DRAM consumption.





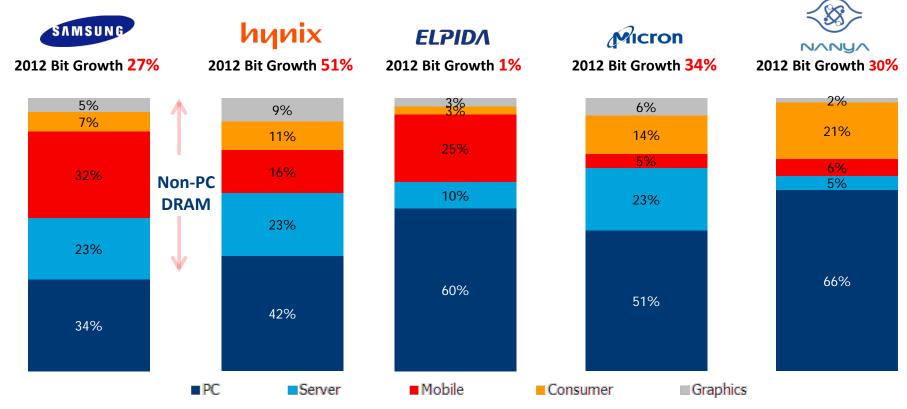
The Changing Mix of Supply





- Samsung, benefitting from strong vertical integration, has highest non-PC contribution.
- Companies whose PC DRAM portion >50% have to reconsider product mix adjustment.

2012(E) Production Mix by Output Chip





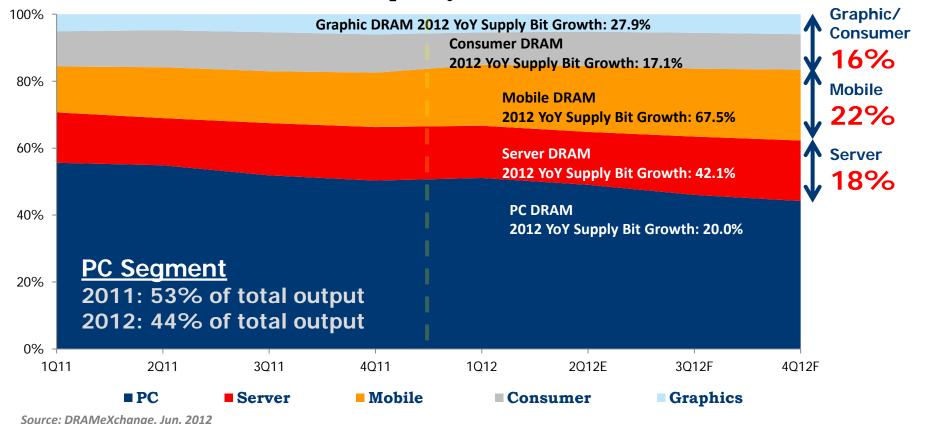
Supply Drivers of 2012: Server, Mobile



Server and Mobile Take 40% of Total Supply Production

- □ 2012: Supply Bit Growth of 30.5% (v.s. Demand Bit Growth of 33.8%)
 - **尽 Server, Mobile**
 - ☑ PC, Graphic

2012 DRAM Output by Production





Winners of PC DRAM Outperform Here, too TRENDFORCE

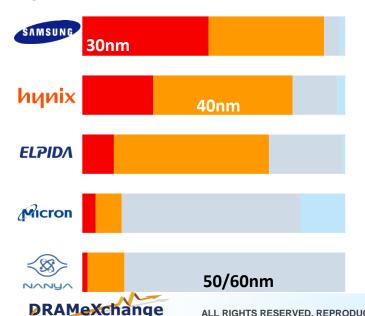
Samsung is By Far the Strongest Leader in Mobile DRAM

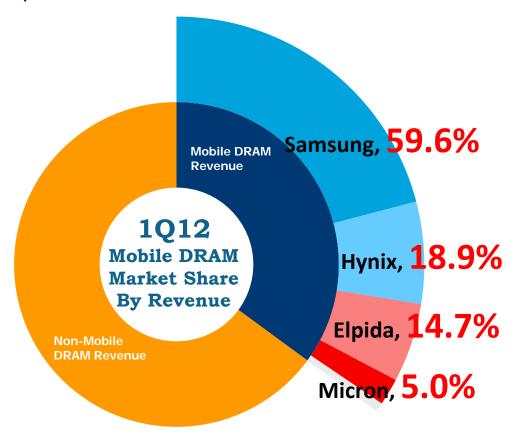
1Q12 DRAM Operating Margin

operating margin		
(1)	SAMSUNG	15%
(2)	hүиix	-18%
(3)	ELPIDΛ	-68%
(4)	Micron	-26%

■ Samsung's leadership is unshakable, mainly benefitting from its complete product portfolio and strong Galaxy family sales.

2Q12 Mobile DRAM Node Breakdown

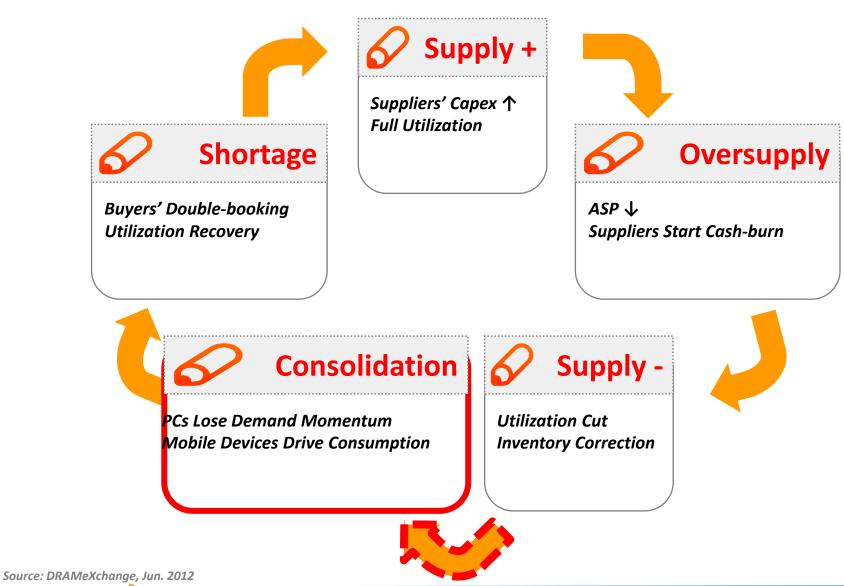




The Broken Cycle, A New Battlefield





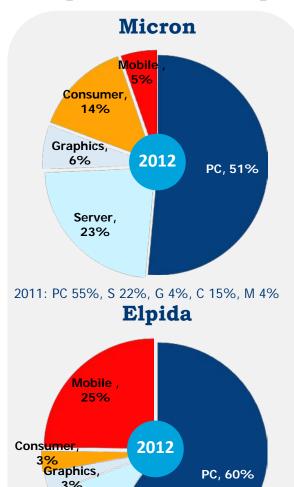


DPAMeYchange

A More Complete Product Offering



Their Cooperation Makes Up What Insufficient Originally



Micron + Elpida will increase penetration of:

- Server: Utilizing Micron's customer base
- Mobile: Micron's NAND + Elpida's Mobile DRAM is competitive, will penetrate high-density MCP market.

Product Diversification
Simulation after Integration

	Chip QTY	%
PC	5,273	49%
Server	1,251	20%
Graphic	453	5%
Consumer	907	10%
Mobile	1,269	16%
Total	9,153	100%

Non-PC DRAM will account for more than

50% of 2012 output after integration.

2011: PC 68%, S 7%, G 3%, C 7%, M 14% Source: DRAMeXchange, Jun. 2012

Server, 10%

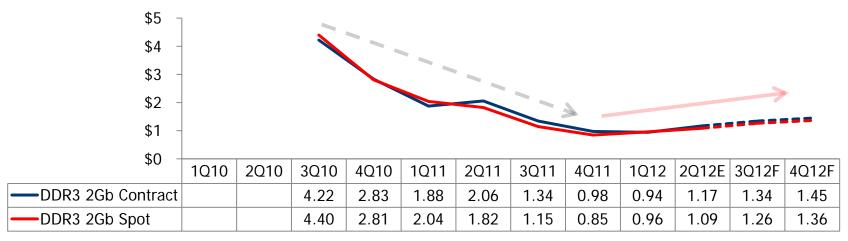


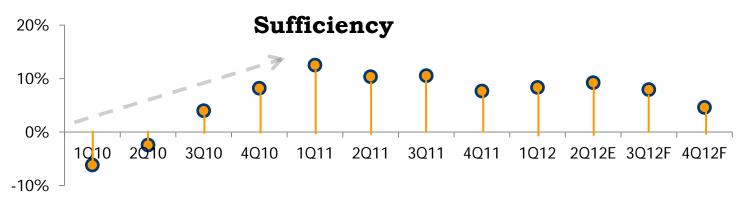
De-coupling Trend of ASP & Sufficiency TRENDFORCE



- Typically, sufficiency ratio is a leading indication of future ASP trend (negatively correlated).
- However, 1H12 ASP trend more strongly reflects supply uncertainty.
- ☐ In 2H, a better demand/supply balance will result in more solid ASP development.

DRAM ASP (Contract & Spot)







Key Take-away



□ DRAM Demand – stimulations in 2H, triggering stronger seasonality

- ✓ By 2012, cloud (server) computing (ultrabook/tablet PC/smartphone) represents majority of DRAM consumption.
- ✓ Ultrabook memory solution decided by product segmentation DDR3LM, LPDDR3 both applicable.
- ✓ Dynamic changes in smartphone and tablet segments, low-end & cost competitive solutions gaining ground → imposing ceiling on mobile DRAM portion of total BOM cost.

□ DRAM Supply – becoming oligopoly market

- ✓ Less price slashing behavior, representing a more rational market \rightarrow stable price trend.
- ✓ In 2012, DRAM market still in oversupply, permanent withdrawal of some capacity necessary.
- ✓ Both economies of scale + product diversification are crucial for profitability.

□ DRAM Sufficiency & ASP

- ✓ 1Q \rightarrow weakest quarter of 2012. 2H'12 ASP gradually move upward (assuming limited impact from China and EU).
- ✓ Suppliers should focus on value-added products: DDR3LM, LPDDR3, on-board memory and DDR4.
- ✓ Commodity & mobile DRAM price gap will narrow mobile DRAM is becoming commoditized in terms of price.
- ✓ The faster DRAM consolidation occurs, the sooner DRAM ASP bottoms out





Thank You

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